



## Material Content Data Sheet



<b>Sales Product Name</b>		BTT6030-1EKA		<b>Issued</b>		24. January 2018		
<b>MA#</b>		MA001618484						
<b>Package</b>		PG-DSO-14-47		<b>Weight*</b>		150.41 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.468	1.64	1.64	16406	16406
leadframe	inorganic material	phosphorus	7723-14-0	0.017	0.01		115	
	non noble metal	zinc	7440-66-6	0.069	0.05		460	
	non noble metal	iron	7439-89-6	1.383	0.92		9198	
	non noble metal	copper	7440-50-8	56.175	37.35	38.33	373487	383260
wire	non noble metal	copper	7440-50-8	0.624	0.41	0.41	4146	4146
encapsulation	organic material	carbon black	1333-86-4	0.170	0.11		1129	
	plastics	epoxy resin	-	7.813	5.19		51944	
	inorganic material	silicondioxide	60676-86-0	76.939	51.17	56.47	511541	564614
leadfinish	non noble metal	tin	7440-31-5	2.472	1.64	1.64	16433	16433
plating	noble metal	silver	7440-22-4	1.470	0.98	0.98	9776	9776
glue	plastics	epoxy resin	-	0.141	0.09		939	
	noble metal	silver	7440-22-4	0.666	0.44	0.53	4426	5365
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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